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MAX 10 FPGA (10M08S, 144-EQFP) Evaluation Kit

User Guide



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The MAX[®]10 Evaluation Kit allows is an entry-level board for evaluating the MAX 10 FPGA technology and Enpirion[®] PowerSoC regulators. You can use this kit to do the following:

- Develop designs for the 10M08S, 144-EQFP FPGA
- Measure FPGA power (VCC_CORE and VCC_IO)
- Bridge between different I/O voltages
- Read and write to the FPGA's NOR flash memory
- Use the FPGA's analog-to-digital converter embedded block to measure incoming analog signals
- Interface to external functions or devices via Arduino UNO R3 connectors or through-hole vias
- Reuse the kit's PCB board and schematic as a model for your design

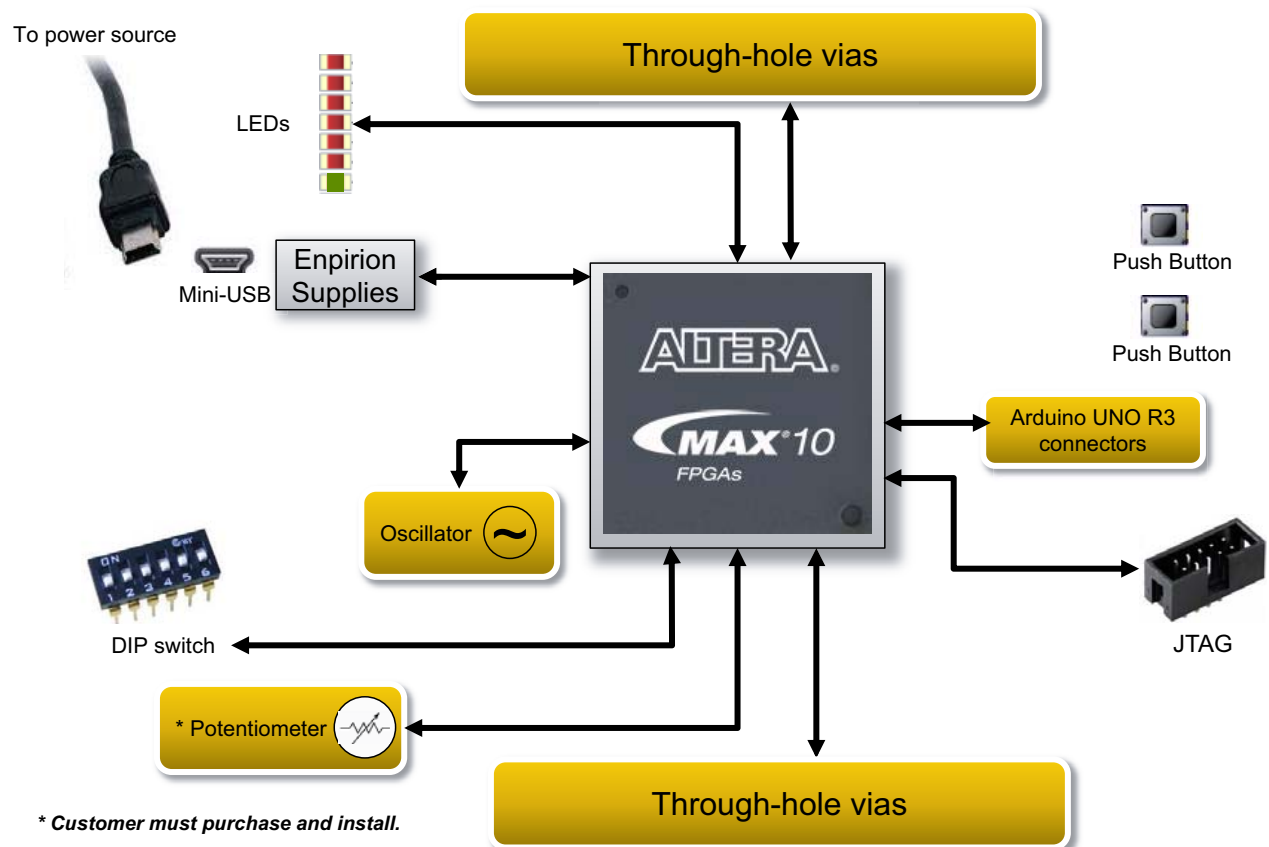
Board Component Blocks

This evaluation kit features the following major component blocks. For a detailed description of the board components, see ["Board Components" on page 3–1](#).

- Altera MAX 10 FPGA, 10M08SAE144C8G, (or ES variant)
 - 8,000 logic elements (LE)
 - 378 kilobits (Kb) M9K memory
 - 32 – 172 (KB) user flash memory
 - One analog-to-digital (ADC) converter, 1 million samples per second (MSPS), 12-bit
- FPGA configuration circuitry
 - JTAG header for external USB-Blaster[™], USB-Blaster II, or Ethernet Blaster download cable
 - Flash storage for two configuration images (factory and user)
 - Dual-image self-configuration via Programmer Object File (.pof)
 - Temporary engineering debug of FPGA design via SRAM Object File (.sof)
- On-Board clocking circuitry
 - 50 MHz oscillator connected to FPGA global clock input
- General user I/O
 - 8 analog input I/O, 14 Arduino I/O, 40 general purpose I/O
 - 5 red user-defined LEDs
 - One green LED to show power from USB cable

- Push button and DIP switches
 - One reconfiguration push button (SW2)
 - One device-wide reset of all registers, push button (SW1)
 - User DIP switch (SW3)
- Power
 - The board is powered by USB cable (from PC or wall jack)
 - One green power-on LED (D6)
 - Probe points for manual, multi-meter measurement of current to calculate power consumption (TP2 - TP5) or to verify voltages on the selected internal nodes (TP1, TP6 - TP9)

Figure 1-1. Example MAX 10 Evaluation Kit Block Diagram



Supported Items Not Included with the Kit

The following items are not included in the kit but were designed to be used in conjunction with this kit.

Table 1–1. Additional Components Not Included with the Kit

Board Reference	Description	Manufacturer	Manufacturing Part Number	Manufacturer Website
R94	Potentiometer	Bourns	3362P-1-103TLF	www.bourns.com
J8, J9	2x20 0.1-inch headers	Sullins Connector Solution	PPPC202LFBN-RC	www.sullinscorp.com
J2, J3, J4, J5	Optional daughter-cards: Arduino UNO R3 revision shields.	Arduino	—	www.adafruit.com www.sainsmart.com www.arduino.com
J1	USB-Blaster Download Cable	Altera	PL-USB-BLASTER-RCN	www.altera.com
J1	USB-Blaster II Download Cable	Altera	PL-USB2-BLASTER	Please call

Powering the Kit

You can apply power the MAX 10 FPGA Evaluation Kit by plugging in the USB cable (J1) to your PC or wall jack. When powered correctly, a pre-programmed design blinks LEDs D1 through D5 ON half a second then OFF half a second.

Installing the USB-Blaster Driver

You can configure the evaluation kit by programming on-chip flash memory using a USB-Blaster™, USB-Blaster II, or Ethernet Blaster download cable. However, for the host computer and board to communicate, you must install the appropriate USB-Blaster, USB-Blaster II, or Ethernet Blaster driver on the host computer.

Installation instructions for the Blaster driver for your operating system are available on the Altera website. On the [Altera Programming Cable Driver Information](#) page of the Altera website, locate the table entry for your configuration and click the link to access the instructions.



You can download the Blaster drivers from the [Download Cables](#) page.

Handling the Kit

When handling the board, it is important to observe the following static discharge precaution:



Without proper anti-static handling, the board can be damaged. Therefore, use anti-static handling precautions when touching the board.

The MAX 10 Evaluation Kit must be stored between -40°C and 100°C . The recommended operating temperature is between 0°C and 85°C .

Factory Default Switch and Jumper Settings

Figure 2–1. Switch Locations and Default Settings (Board Top)

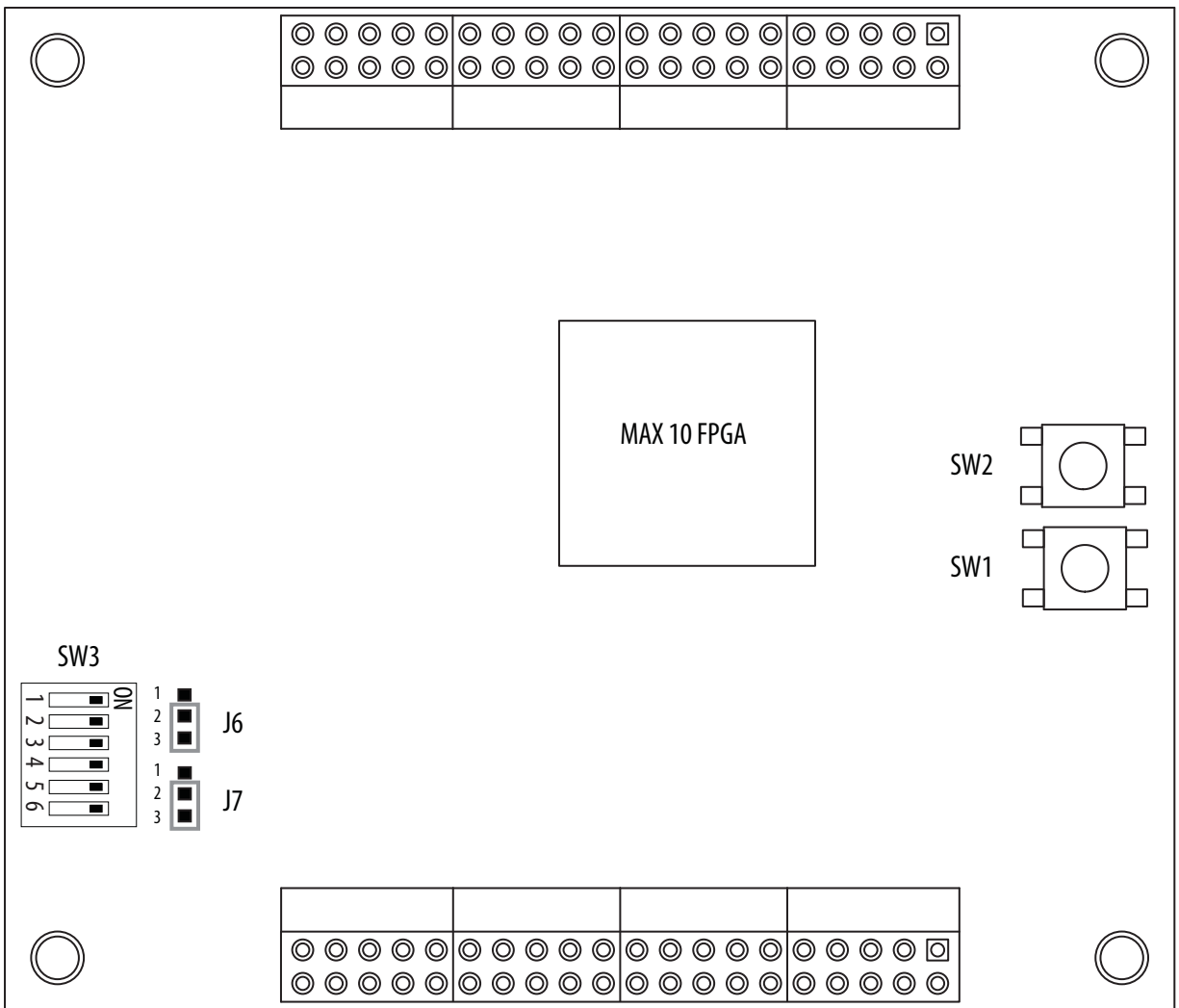


Table 2–1. Default SW3 DIP Switch Settings (Part 1 of 2)

Switch	Function	Default Position
1	User-defined	On
2	User-defined	On
3	User-defined	On
4	User-defined	On

Table 2-1. Default SW3 DIP Switch Settings (Part 2 of 2)

Switch	Function	Default Position
5	User-defined	On
6	BOOT_SEL: Use this switch to choose CFM0, CFM1, or CFM2 image as the first image in a dual-image configuration. If BOOT_SEL is set to low, the first boot image is CFM0 image, If set to high, the first boot image is the CFM1 or CFM2 image. By default, the FPGA setting for this pin is tri-stated.	On

Table 2-2. Default Jumper Settings

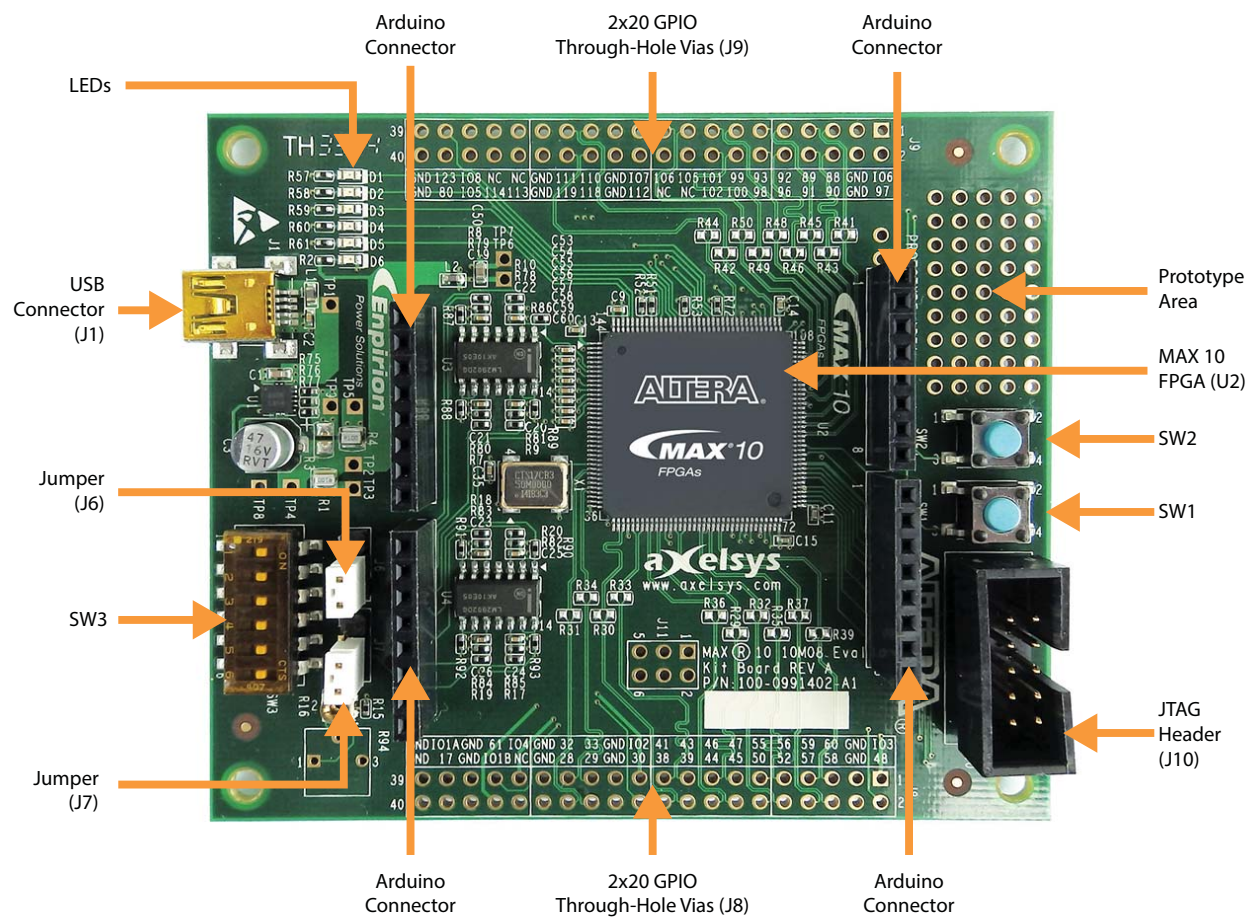
Jumper	Function	Setting
J6	Jumper for analog input channel #8. Default connection is to GND.	Pins 2 and 3
J7	Jumper for analog input channel #7. Default connection is to potentiometer.	Pins 2 and 3

This chapter introduces all the important components on the evaluation kit. [Figure 3-1](#) illustrates major component locations and [Table 3-1](#) provides a brief description of all features of the board.

Board Overview

This section provides an overview of the evaluation kit, including an annotated board image and component descriptions.

Figure 3-1. Overview of the MAX 10 FPGA Evaluation Kit Features



[Table 3-1](#) describes the components and lists their corresponding board references.

Table 3-1. MAX 10 FPGA (10M08S, 144-EQFP) Evaluation Kit Components

Board Reference	Type	Description
Featured Device		
U2	FPGA	10M08SAE144C8G, (or ES variant) Plastic Enhanced Quad Flat Pack (EQFP), 144 pins, 22 mm x 22 mm. For package details, refer to the Altera Device Package Information page.
Configuration, Status, and Setup Elements		
J6	Jumper for analog input channel #8	Default connection is to GND. Change jumper to pins 1 and 2 to switch analog source to Arduino header.
J7	Jumper for analog input channel #7	Default connection is to potentiometer (customer option to purchase and install). Change jumper to pins 1 and 2 to switch analog source to Arduino header.
SW3	User-defined DIP switch	6-position switch. SW3.1 through SW3.5 are user-defined. SW3.6 is predefined for dual-image configuration.
D1, D2, D3, D4, D5	LED, red	These LEDs cycle off and on when the kit is powered on.
D6	Power LED, green	Illuminates when USB power is present.
SW2	FPGA reconfiguration push-button	Toggling this button causes the FPGA to reconfigure from on-die Configuration Flash Memory (CFM).
Clock Circuitry		
X1	50-MHz oscillator	50-MHz crystal oscillator for general purpose logic.
General User Input and Output		
D1, D2, D3, D4, D5	User-defined LEDs, red	User-defined LEDs.
SW1	FPGA register push-button	Toggling this button resets all registers in the FPGA.
R94	Potentiometer	You must purchase and install this device to provide analog inputs signals to the MAX 10 ADC IP block (analog input channel 8).
Connectors		
J2, J3, J4, J5	Arduino UNO R3 connectors	You can purchase Arduino Uno R3 compatible Shields (i.e. daughtercards) to connect to the Arduino headers installed on the board.
J10	JTAG header	Connects an Altera USB-Blaster, USB-Blaster II, or Ethernet Blaster to program or configure the FPGA.
—	Prototype Area	This through-hole area is not connected to the FPGA. You can use this area to connect or solder additional components.
Power Supply		
J1	USB connector	Connects a USB cable to a power source.

Featured Device: MAX 10 FPGA

The evaluation kit features the MAX 10 FPGA 10M08SAE144C8G device (U2) in a 144-pin Plastic Enhanced Quad Flat Pack (EQFP) package.


 For more detailed information about the MAX 10 FPGA device family, refer to the [MAX 10 FPGA Device Overview](#).

Table 3–2. MAX 10 FPGA Component Reference and Manufacturing Information

Board Reference	Description	Manufacturer	Manufacturing Part Number	Manufacturer Website
U2	10M08SAE144C8G, (or ES variant) Plastic Enhanced Quad Flat Pack (EQFP), 144 pins, 20 mm x 20mm	Altera Corporation	10M08SAE144C8GES	www.altera.com/max10

Configuration

The evaluation kit supports two configuration methods:


- JTAG header (J10) for configuration by downloading a **.sof** file to the FPGA. Any power cycling of the FPGA or reconfiguration will power up the FPGA to a blank state.
- JTAG header (J10) for programming of the on-die FPGA Configuration Flash Memory (CFM) via a **.pof** file. Any power cycling of the FPGA or reconfiguration will power up the FPGA in self-configuration mode, using the files stored in the CFM.

FPGA Programming over External USB-Blaster

The JTAG header provides a method for configuring the FPGA (U2) using an external USB-Blaster™, USB-Blaster II, or Ethernet Blaster download cable with the Quartus II Programmer running on a PC. The external download cable connects to the board through the JTAG header (J10).

Configuring the FPGA Using the Quartus II Programmer

You can use the Quartus II Programmer to configure the FPGA with a **.sof**. Before configuring the FPGA, ensure that the Quartus II Programmer and the USB-Blaster driver are installed on the host computer, the USB cable is connected to the evaluation kit, power to the board is on, and no other applications that use the JTAG chain are running.

 To successfully use the USB-Blaster cable, disconnect it before power cycling the board. After you power cycled the board, then reconnect the USB-Blaster cable.

To configure the MAX 10 FPGA FPGA, perform the following steps:

1. Start the Quartus II Programmer.
2. Click **Auto Detect** to display the devices in the JTAG chain.

3. Click **Add File** and select the path to the desired **.sof**.
4. Turn on the **Program/Configure** option for the added file.
5. Click **Start** to download the selected file to the FPGA. Configuration is complete when the progress bar reaches 100%.

The Quartus II Convert Programming File (CPF) GUI can be used to generate a **.pof** file that can use for internal configuration. You can directly program the MAX 10 device's flash which included Configuration Flash Memory (CFM) and User Flash Memory (UFM) by using a download cable with the Quartus II software programmer.

Selecting Internal Configuration Scheme

For all MAX 10 devices except 10M02 device, there are total of 5 different modes can be selected when using Internal Configuration. The internal configuration scheme needs to be selected before design compilation.

To select the configuration mode, follow these steps:

1. Open the Quartus II software and load a project using MAX 10 device family.
2. On the Assignments menu, click **Settings**. The **Settings** dialog box appears.
3. In the Category list, select **Device**. The Device page appears.
4. Click **Device and Pin Options**.
5. In the **Device and Pin Options** dialog box, click the **Configuration** tab.
6. In the **Configuration Scheme** list, select **Internal Configuration**.
7. In the **Configuration Mode** list, select 1 out of 5 configuration modes except 10M02 device, which has only 2 modes available.
8. Turn on **Generate compressed bitstreams** if needed.
9. Click **OK**.

Generating a .pof File with ICB Settings

To generate a **.pof** file from a **.sof** file for internal configuration, follow these steps:

1. On the File menu, click **Convert Programming Files**.
2. Under **Output programming file**, select Programmer Object File (**.pof**) in the Programming file type list.
3. In the **Mode** list, select **Internal Configuration**.

4. To set the ICB settings, click **Option/Boot Info** button. An ICB setting dialog box will appear.

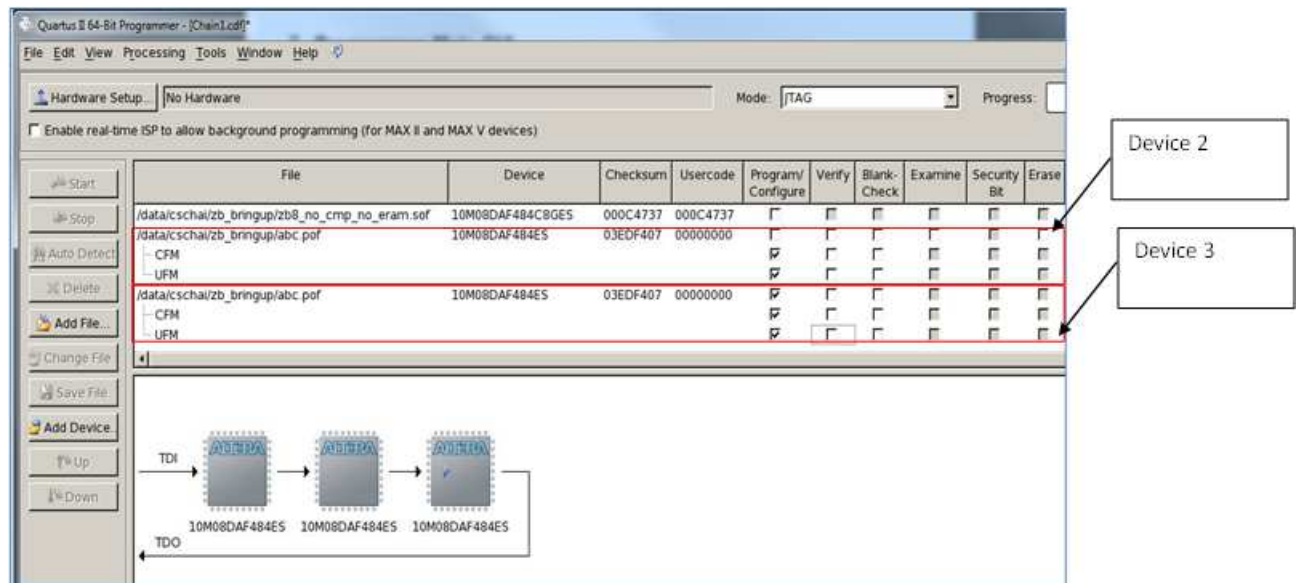
Several ICB settings can be set through the ICB setting dialog box, including:

- Power on Reset Scheme: Instant On, Fast POR Delay or Slow POR Delay.
 - Enable user IOs weak pull up during configuration check box.
 - Enable the JTAG Security check box.
 - Verify Protect check box.
 - Enable watchdog for dual boot and watching value (initially grayed out, after add 2 sof page with 2 design that compiled with Dual Compressed Internal Images, the watchdog setting will then be enable).
 - User Flash Memory settings.
5. In the **File name** box, specify the file name for the programming file you want to create.
 6. To generate a Memory Map File (**.map**), turn on **Create Memory Map File (Auto generate output_file.map)**. In the **.map** file, not only will show the address of the CFM and UFM, but also will contain the information of the ICB setting that user set through the **Option/Boot Info** dialog box.
 7. You can add an SRAM Object File (**.sof**) through **Input files to convert** list. The maximum sof page is two.
 8. After set all the desirable settings, click Generate to generate related programming file.

Programming Internal Flash Memory

After generating the .pof file, Quartus II Programmer can be used to program the internal flash memory through JTAG connection. The following shows an example of the Quartus II Programmer.

Figure 3-2. Quartus II Programmer



There are 2 scenarios when using the Quartus II Programmer to program a .pof file into MAX 10 devices:

1. For Device 2, the Programmer will just erase and configure CFM and UFM sector in the internal flash memory, but the ICB setting will be preserved. However, before starting the programming, the makes sure the ICB setting in the device and the ICB setting in the .pof file are the same. If both ICB settings are different, the Programmer still erases and programs the full internal memory including the ICB setting, even though only CFM and UFM are selected in the Programmer.
2. For Device 3, the Programmer will erase and program full internal memory, which includes the ICB setting, CFM, and UFM.

Before enabling real-time ISP for internal flash memory programming, you need to ensure the MAX 10 FPGA is in user mode, otherwise the programming process will fail.

Clock Circuitry

General-Purpose Clock

One general-purpose clock is provided to the FPGA global clock inputs for general FPGA design. The clock source is from the following component:

- A 50-MHz oscillator to the clock input CLK0p of bank 2.

Figure 3-3 shows the general purpose clock going in to the evaluation kit.

Figure 3-3. MAX 10 FPGA (10M08S, 144-EQFP) Evaluation Kit General Purpose Clock



Arduino Connectors

Arduino connectors J3, J4, and J5 connect to the MAX 10 FPGA. Any analog inputs sourced through the Arduino header J4 are first filtered by the evaluation boards op-amp based circuit. This circuit scales the maximum allowable voltage per the Arduino specification (5.0V) to the maximum allowable voltage per the MAX 10 FPGA ADC IP block (2.5V).


 You can download an example design with pin locations and assignments completed according to the following table from the [Altera Design Store](#). In the MAX 10 FPGA Evaluation Kit, under **Design Examples**, click **MAX 10 Evaluation Kit Baseline Pinout**.

Table 3-3. Arduino Connector Pin Assignments, Signal Names and Functions (Part 1 of 2)

Board Reference	Schematic Signal Name	MAX 10 FPGA Device Pin Number	Description
J3.1	ANALOG_VREF	5	Arduino analog Vref input
J3.2	GND	—	Arduino GND input
J3.3	ARDUINO_IO13	70	Arduino digital I/O input to FPGA
J3.4	ARDUINO_IO12	69	Arduino digital I/O input to FPGA
J3.5	ARDUINO_IO11	66	Arduino digital I/O input to FPGA
J3.6	ARDUINO_IO10	65	Arduino digital I/O input to FPGA
J3.7	ARDUINO_IO9	64	Arduino digital I/O input to FPGA
J3.8	ARDUINO_IO8	62	Arduino digital I/O input to FPGA
J4.1	ARDUINO_A0	6	Arduino analog channel input through the op-amp filter circuit to the FPGA ADC IP input channel ADC1N1
J4.2	ARDUINO_A1	7	Arduino analog channel input through the op-amp filter circuit to the FPGA ADC IP input channel ADC1IN2
J4.3	ARDUINO_A2	8	Arduino analog channel input through the op-amp filter circuit to the FPGA ADC IP input channel ADC1IN3
J4.4	ARDUINO_A3	10	Arduino analog channel input through the op-amp filter circuit to the FPGA ADC IP input channel ADC1IN4

Table 3-3. Arduino Connector Pin Assignments, Signal Names and Functions (Part 2 of 2)

Board Reference	Schematic Signal Name	MAX 10 FPGA Device Pin Number	Description
J4.5	ARDUINO_A4	11	Arduino analog channel input through the op-amp filter circuit to the FPGA ADC IP input channel ADC1IN5
J4.6	ARDUINO_A5	12	Arduino analog channel input through the op-amp filter circuit to the FPGA ADC IP input channel ADC1IN6
J4.7	ARDUINO_A6	13	Arduino analog channel input through the op-amp filter circuit to the FPGA ADC IP input channel ADC1IN7
J4.8	ARDUINO_A7	14	Arduino analog channel input through the op-amp filter circuit to the FPGA ADC IP input channel ADC1IN8
J5.1	ARDUINO_IO7	86	Arduino digital I/O input to FPGA
J5.2	ARDUINO_IO6	84	Arduino digital I/O input to FPGA
J5.3	ARDUINO_IO5	81	Arduino digital I/O input to FPGA
J5.4	ARDUINO_IO4	79	Arduino digital I/O input to FPGA
J5.5	ARDUINO_IO3	77	Arduino digital I/O input to FPGA
J5.6	ARDUINO_IO2	76	Arduino digital I/O input to FPGA
J5.7	ARDUINO_IO1	75	Arduino digital I/O input to FPGA
J5.8	ARDUINO_IO0	74	Arduino digital I/O input to FPGA

General User Input/Output

This section describes the user I/O interface to the FPGA:

- User-defined DIP switch
- User-defined LEDs

User-Defined DIP Switch

Board reference SW3 is a 6-pin DIP switch. Switches 1 through 5 are user-defined, and provide additional FPGA input control. When the switch is in the OPEN or OFF position, a logic 1 is selected. When the switch is in the CLOSED or ON position, a logic 0 is selected. There is no board-specific function for these switches.

Table 3-4 lists the user-defined DIP switch schematic signal names and their corresponding MAX 10 FPGA pin numbers.

Table 3-4. User-Defined DIP Switch Schematic Signal Names and Functions

Board Reference SW3	Schematic Signal Name	I/O Standard	MAX 10 FPGA Device Pin Number
1	Switch 1	3.3-V	120
2	Switch 2	3.3-V	124
3	Switch 3	3.3-V	127
4	Switch 4	3.3-V	130
5	Switch 5	3.3-V	131

User-Defined LEDs

The development board includes five user-defined LEDs. Board references D1 through D5 are user LEDs that allow status and debugging signals to be driven to the LEDs from the designs loaded into the MAX 10 FPGA device. The LEDs illuminate when a logic 0 is driven, and turns off when a logic 1 is driven. There is no board-specific function for these LEDs.

Table 3-5 lists the user-defined LED schematic signal names and their corresponding MAX 10 FPGA pin numbers.

Table 3-5. User-Defined LED Schematic Signal Names and Functions

Board Reference	Schematic Signal Name	I/O Standard	MAX 10 FPGA Device Pin Number
D1	LED1	2.0-V	132
D2	LED2	2.0-V	134
D3	LED3	2.0-V	135
D4	LED4	2.0-V	140
D5	LED5	2.0-V	141

Power Supply

The development board is powered up through a USB cable. The green LED illuminates when the board is powered up.

Power Measurement

In order to measure the actual power of the FPGA, there are test pads on the board to be used as probe points for multi-meter probes. The user can measure the current and using the equation $P = R \times I^2$. (Power = Resistance x Current Squared), calculate the power dissipation.

Test pads TP2 and TP3 are used to measure the current consumed by the FPGA core. Test pads TP4 and TP5 are used to measure the current consumed by all of the FPGA's I/O banks. All the other test pads are used to verify the voltage levels of various nodes on the board.

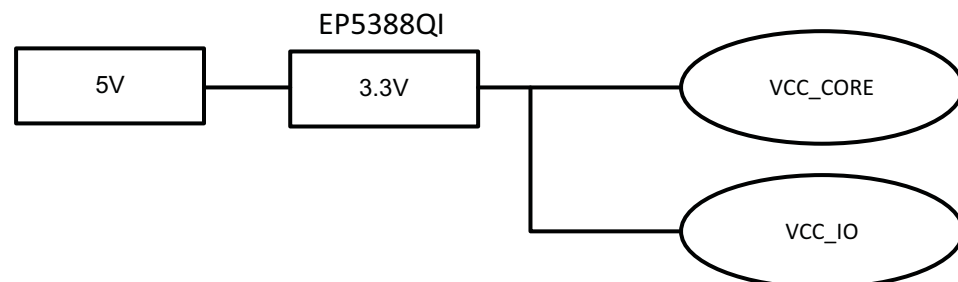
Table 3-6. Power Measurement Details

Test Pad #'s	Measuring	Description	Expected Value
TP2 - TP3	FPGA core current	Power calculation for FPGA Vcc-core power consumption. Resistor R1 = 0.1 ohms. Current measured by user's multi-meter.	___ mWatts
TP4 - TP5	FPGA I/O current	Power calculation for FPGA Vcc-io power consumption. Resistor R4 = 0.1 ohms. Current measured by user's multi-meter.	___ mWatts
Test Pad #'s	Measuring	Description	Expected Value
TP1	Board input voltage	Verify the USB input voltage	5.0-volts
TP6	Analog voltage	Verify the proper voltage required by the FPGA Vcca inputs	3.3-volts
TP7	Analog GND	Verify the proper voltage required by the FPGA ADC IP block GND inputs	0-volts
TP8	Digital GND	Verify the proper voltage required by the FPGA digital GND inputs	0-volts
TP9	Digital GND	Verify the proper voltage required by the FPGA digital GND inputs	0-volts

Power Distribution System

Figure 3-4 shows the power distribution system on the development board.


Figure 3-4. Power Distribution System



Temperature Sense

The ADCs provide the devices with built-in capability for on-die temperature monitoring and external analog signal conversion.

Temperature sensing mode—monitors external temperature data input with a sampling rate of up to 50 kilosamples per second. In dual ADC devices, only the first ADC block contains the temperature sensing diode.

 For more information on the ADC, refer to the [MAX 10 FPGA Device Overview](#).

This chapter provides additional information about the document and Altera.

Document Revision History

The following table shows the revision history for this document.

Date	Version	Changes
September 2015	1.2	<ul style="list-style-type: none"> ■ Corrected sense of switches in “User-Defined DIP Switch” on page 3–8. ■ Added link to Altera Design Store in “Arduino Connectors” on page 3–7
October 2014	1.1	Corrected FPGA pin number for SW3.2 from 121 to 124.
September 2014	1.0	Initial release.

How to Contact Altera

To locate the most up-to-date information about Altera products, refer to the following table.

Contact ⁽¹⁾	Contact Method	Address
Technical support	Website	www.altera.com/support
Technical training	Website	www.altera.com/training
	Email	custrain@altera.com
Product literature	Website	www.altera.com/literature
Nontechnical support (general) (software licensing)	Email	nacomp@altera.com
	Email	authorization@altera.com











Note to Table:

(1) You can also contact your local Altera sales office or sales representative.

Typographic Conventions

The following table shows the typographic conventions this document uses.

Visual Cue	Meaning
Bold Type with Initial Capital Letters	Indicate command names, dialog box titles, dialog box options, and other GUI labels. For example, Save As dialog box. For GUI elements, capitalization matches the GUI.
bold type	Indicates directory names, project names, disk drive names, file names, file name extensions, software utility names, and GUI labels. For example, <code>\qdesigns</code> directory, D: drive, and <code>chiptrip.gdf</code> file.
<i>Italic Type with Initial Capital Letters</i>	Indicate document titles. For example, <i>Stratix IV Design Guidelines</i> .

Visual Cue	Meaning
<i>italic type</i>	Indicates variables. For example, $n + 1$. Variable names are enclosed in angle brackets (< >). For example, <file name> and <project name>.pdf file.
Initial Capital Letters	Indicate keyboard keys and menu names. For example, the Delete key and the Options menu.
"Subheading Title"	Quotation marks indicate references to sections in a document and titles of Quartus II Help topics. For example, "Typographic Conventions."
Courier type	Indicates signal, port, register, bit, block, and primitive names. For example, data1, tdi, and input. The suffix n denotes an active-low signal. For example, resetn. Indicates command line commands and anything that must be typed exactly as it appears. For example, c:\qdesigns\tutorial\chiptrip.gdf. Also indicates sections of an actual file, such as a Report File, references to parts of files (for example, the AHDL keyword SUBDESIGN), and logic function names (for example, TRI).
	An angled arrow instructs you to press the Enter key.
1., 2., 3., and a., b., c., and so on	Numbered steps indicate a list of items when the sequence of the items is important, such as the steps listed in a procedure.
	Bullets indicate a list of items when the sequence of the items is not important.
	The hand points to information that requires special attention.
	The question mark directs you to a software help system with related information.
	The feet direct you to another document or website with related information.
	The multimedia icon directs you to a related multimedia presentation.
	A caution calls attention to a condition or possible situation that can damage or destroy the product or your work.
	A warning calls attention to a condition or possible situation that can cause you injury.
	The envelope links to the Email Subscription Management Center page of the Altera website, where you can sign up to receive update notifications for Altera documents.
	The feedback icon allows you to submit feedback to Altera about the document. Methods for collecting feedback vary as appropriate for each document.

Compliance and Conformity Statements

CE EMI Conformity Caution

This evaluation kit is delivered conforming to relevant standards mandated by Directive 2004/108/EC. Because of the nature of programmable logic devices, it is possible for the user to modify the kit in such a way as to generate electromagnetic interference (EMI) that exceeds the limits established for this equipment. Any EMI caused as the result of modifications to the delivered material is the responsibility of the user.

